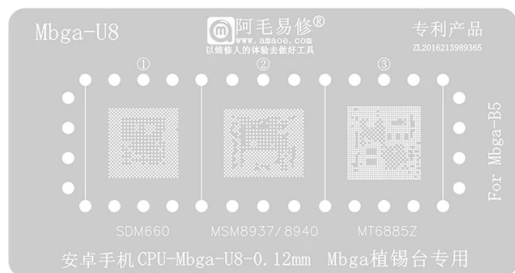


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Mbga-U8 0.12MM

AMAOE BGA stencil reballing Mbga-U8 for SDM660 MSM8937/8940, MT6885Z for Mbga-B5

Product ID: 22980

Price: **7.00 EUR**

Product weight: **0.20 kg**

Description:

AMAOE BGA stencil reballing Mbga-U8 for SDM660 MSM8937/8940, MT6885Z for Mbga-B5 - the sieves are a product made of steel resistant to high temperatures and deformations. Precise laser-cut templates facilitate positioning during work.

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